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NCE P-Channel Enhancement Mode Power MOSFET

Description

The NCE60P50 uses advanced trench technology and design to provide excellent $R_{DS(ON)}$ with low gate charge .This device is well suited for high current load applications.

General Features

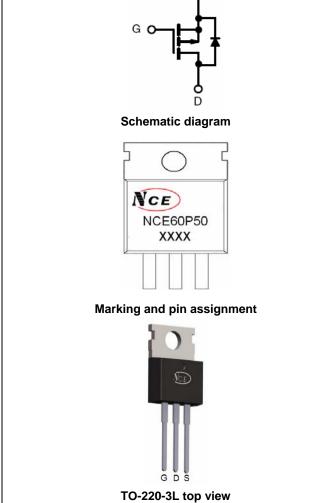
- V_{DS} =-60V,I_D =-50A
 R_{DS(ON)} <28mΩ @ V_{GS}=-10V
- High density cell design for ultra low Rdson
- Fully characterized avalanche voltage and current
- Good stability and uniformity with high E_{AS}
- Excellent package for good heat dissipation

Application

Load switch

100% UIS TESTED!

100% ΔVds TESTED!



Package Marking and Ordering Information

	<u> </u>	V			
Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
NCE60P50	NCE60P50	TO-220-3L	-	-	-

Absolute Maximum Ratings (T_c=25℃unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	VDS	-60	V
Gate-Source Voltage	V _{GS}	±20	V
Drain Current-Continuous	Ι _D	-50	А
Drain Current-Continuous(T _C =100℃)	I _D (100℃)	-35	А
Pulsed Drain Current	I _{DM}	-150	А
Maximum Power Dissipation	PD	95	W
Derating factor		0.76	W/℃
Single pulse avalanche energy (Note 5)	E _{AS}	722	mJ
Operating Junction and Storage Temperature Range	T _J ,T _{STG}	-55 To 150	°C



Pb Free Product



Thermal Characteristic

Thermal Resistance, Junction-to-Case ^(Note 2)	R _{θJC}	1.31	°C/W	1
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Electrical Characteristics (T_C=25°C unless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit
Off Characteristics	·					
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V I _D =-250µA	-60	-	-	V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =-60V,V _{GS} =0V	-	-	-1	μA
Gate-Body Leakage Current	I _{GSS}	V _{GS} =±20V,V _{DS} =0V	-	-	±100	nA
On Characteristics (Note 3)	·					
Gate Threshold Voltage	V _{GS(th)}	$V_{DS}=V_{GS}$, $I_{D}=-250\mu A$	-1.2	-1.9	-2.5	V
Drain-Source On-State Resistance	R _{DS(ON)}	V _{GS} =-10V, I _D =-20A	-	23	28	mΩ
Forward Transconductance	g fs	V _{DS} =-10V,I _D =-10A	-	25	-	S
Dynamic Characteristics (Note4)	·					
Input Capacitance	C _{lss}		-	6460	-	PF
Output Capacitance	Coss	V _{DS} =-25V,V _{GS} =0V, F=1.0MHz	-	719	-	PF
Reverse Transfer Capacitance	Crss		-	535	-	PF
Switching Characteristics (Note 4)	·					
Turn-on Delay Time	t _{d(on)}		-	15	-	nS
Turn-on Rise Time	tr	V_{DD} =-30V, R _L =1.5 Ω ,	-	17	-	nS
Turn-Off Delay Time	t _{d(off)}	V _{GS} =-10V,R _G =3Ω	-	40	-	nS
Turn-Off Fall Time	t _f		-	45	-	nS
Total Gate Charge	Qg	V - 20 L - 40A	-	75		nC
Gate-Source Charge	Q _{gs}	V _{DS} =-30,I _D =-10A, V _{GS} =-10V	-	16		nC
Gate-Drain Charge	Q _{gd}	V _{GS} =-10V	-	19		nC
Drain-Source Diode Characteristics	·					
Diode Forward Voltage (Note 3)	V _{SD}	V _{GS} =0V,I _S =-10A	-		-1.2	V
Diode Forward Current (Note 2)	Is		-	-	-20	Α
Reverse Recovery Time	t _{rr}	TJ = 25°C, IF =- 10A	-	50		nS
Reverse Recovery Charge	Qrr	di/dt = -100A/µs ^(Note3)	-	59		nC
Forward Turn-On Time	t _{on}	Intrinsic turn-on time is negligible (turn-on is dominated by LS+LD				

Notes:

- 1. Repetitive Rating: Pulse width limited by maximum junction temperature.
- **2.** Surface Mounted on FR4 Board, t \leq 10 sec.
- **3.** Pulse Test: Pulse Width \leq 300µs, Duty Cycle \leq 2%.
- 4. Guaranteed by design, not subject to production
- **5.** E_{AS} condition: Tj=25 $^\circ\!\!\mathrm{C}$,V_{DD}=-20V,V_G=-10V,L=1mH,Rg=25\Omega,I_{AS}=38A

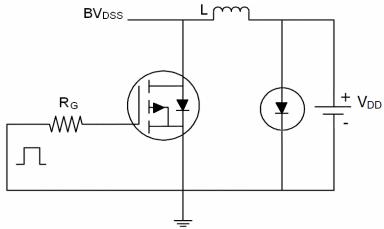


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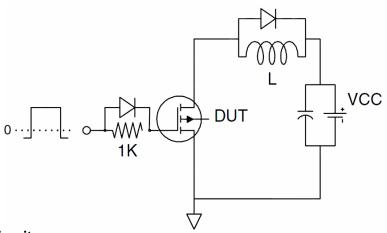




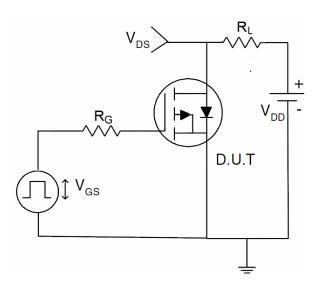
Test Circuit 1) E_{AS} Test Circuit



2) Gate Charge Test Circuit



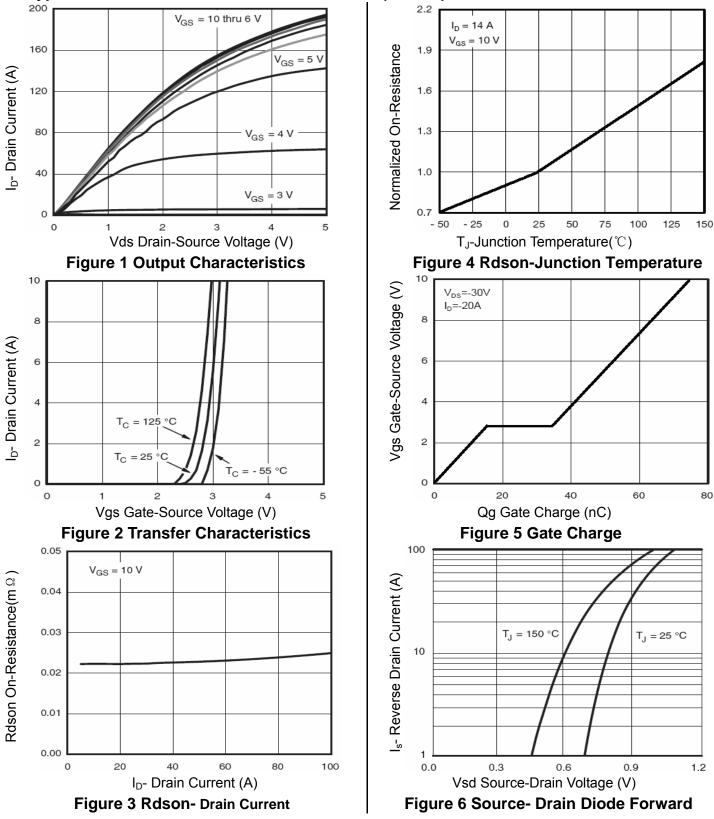
3) Switch Time Test Circuit













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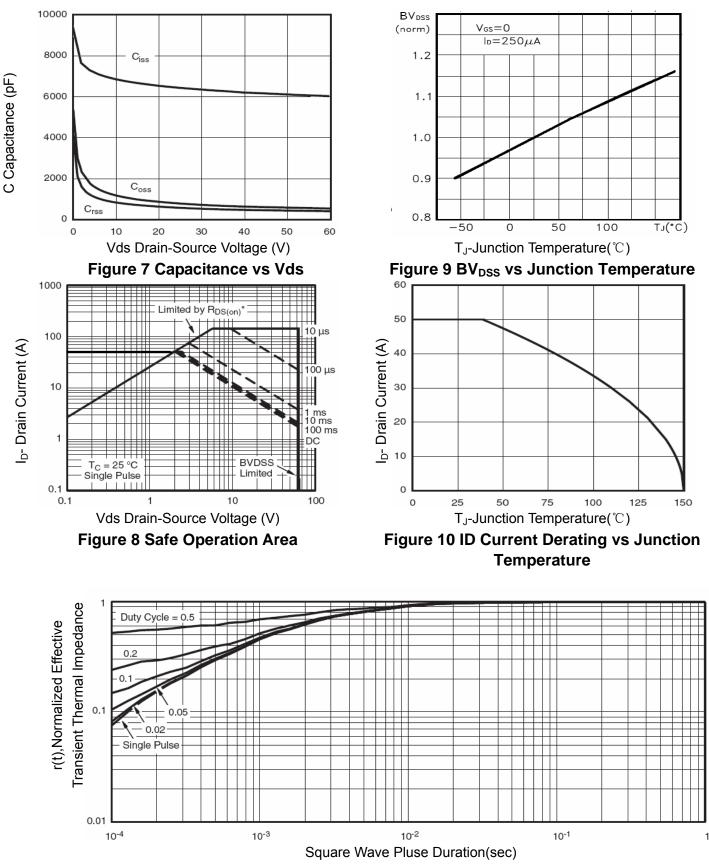


Figure 11 Normalized Maximum Transient Thermal Impedance

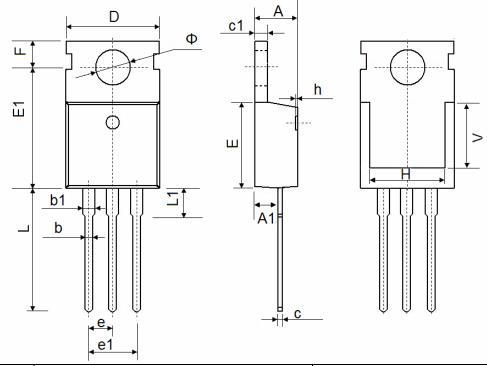


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NCE60P50

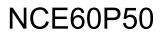
TO-220-3L Package Information



Symbol	Dimensions	In Millimeters	Dimensions In Inches		
	Min.	Max.	Min.	Max.	
A	4.400	4.600	0.173	0.181	
A1	2.250	2.550	0.089	0.100	
b	0.710	0.910	0.028	0.036	
b1	1.170	1.370	0.046	0.054	
с	0.330	0.650	0.013	0.026	
c1	1.200	1.400	0.047	0.055	
D	9.910	10.250	0.390	0.404	
E	8.9500	9.750	0.352	0.384	
E1	12.650	12.950	0.498	0.510	
е	2.540) TYP.	0.100 TYP.		
e1	4.980	5.180	0.196	0.204	
F	2.650	2.950	0.104	0.116	
Н	7.900	8.100	0.311	0.319	
h	0.000	0.300	0.000	0.012	
L	12.900	13.400	0.508	0.528	
L1	2.850	3.250	0.112	0.128	
V	7.500 REF.		0.295 REF.		
Ф	3.400	3.800	0.134	0.150	







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